

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT5919572

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Chia-Chang Lin	01/15/2020
Li-Chung Chen	01/15/2020
Ching-Yao Su	01/15/2020
Yuan-Jih Chu	01/15/2020
RECEIVING PARTY DATA	
Name:	Realtek Semiconductor Corp.
Street Address:	2 Innovation Rd. II, Science Park
City:	HsinChu
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16747488
CORRESPONDENCE DATA	
Fax Number:	(703)997-4517
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	3027291562
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ATTORNEY DOCKET NUMBER:	REAP1020USA
NAME OF SUBMITTER:	KATE YEH
SIGNATURE:	/KATE YEH/
DATE SIGNED:	01/20/2020
Total Attachments: 8	
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**COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION
USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT**

Title of Invention:

**ELECTRONIC SYSTEM WITH RFI CANCELATION MECHANISM AND RELATED
RFI CANCELATION METHOD**

As the below named inventor, I hereby declare that:
This declaration is directed to:

- The attached application, or
- United States application number _____ filed on _____, or
- PCT international application number _____ filed on _____

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

In consideration of the payment by Realtek Semiconductor Corp. having a postal address of
2 Innovation Rd. II, Science Park, HsinChu 30076, Taiwan, R.O.C.

(referred to as "ASSIGNEE" below) to I of the sum of One Dollar (\$ 1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

I hereby sell, assign and transfer to ASSIGNEE and the successors and assignees of the ASSIGNEE the entire right, title and interest in and to any and all improvements which are disclosed in the invention as above-identified application and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof.

I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

I further covenant that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to I and will testify as to the same in any interference, litigation proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal

representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.
IN WITNESS WHEREOF, I have hereunto set hand and seal this on the date(s) indicated.

Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use this form for each additional inventor.

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: **Chia-Chang Lin**

Date: **JAN 15 2020**

Signature: Chia-Chang Lin

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Docket No REAP1020USA

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: **Li-Chung Chen**

Date: **JAN 15 2020**

Signature: Li Chung Chen

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Docket No REAP1020USA

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: **Ching-Yao Su**

Date: **JAN 15 2020**

Signature:

Ching-Yao Su

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Docket No REAP1020USA

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: **Yuan-Jih Chu**

Date: **JAN 15 2020**

Signature: Yuan-Jih chu

NPO#REA-P1020-USA:0
CUST#108A-109US

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F#NPO-P0002E-US1201
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RECORDED: 01/20/2020

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